

For use with IDT's VCXO-based Synchronization PLLs

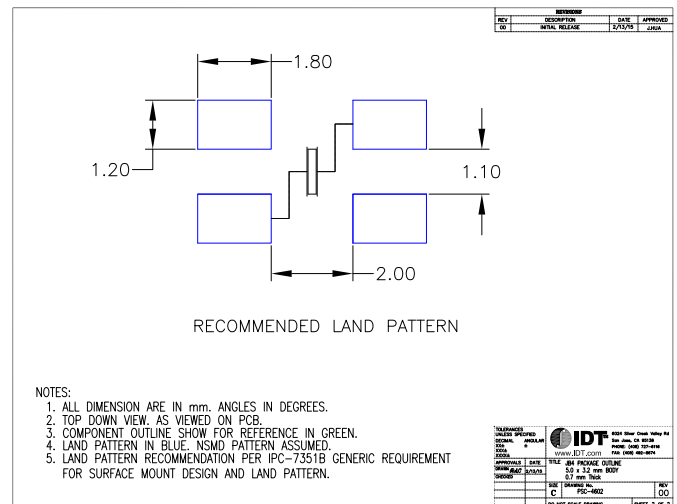
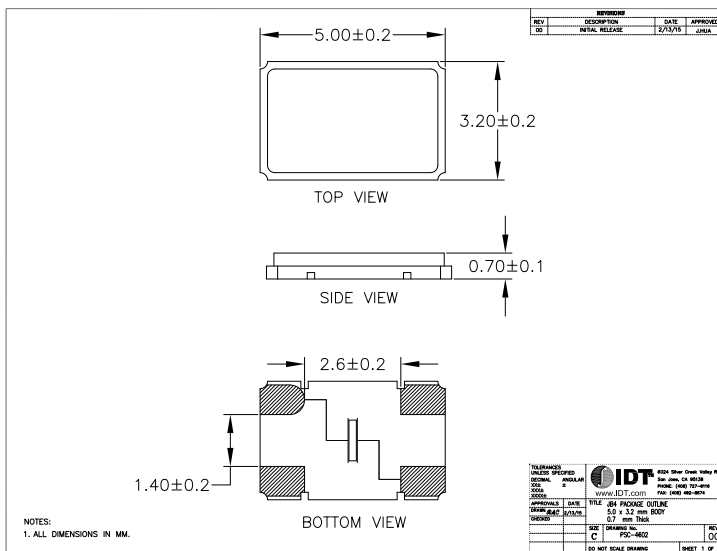
DATASHEET

Specifications

Parameters	Ratings/Units
Frequency	25.000 MHz
Resonance Mode	Fundamental
Frequency Tolerance @ 25°C	±10 PPM
Frequency Stability, ref @ 25°C Over Operating Temperature Range	±20 PPM
Temperature Range: Operating (TOPR) Storage (TSTG)	-40°C ~ +85°C -40°C ~ +85°C
Equivalent Series Resistance (ESR)	40 Ohms
Shunt Capacitance (Co)	7.0 pF
Load Capacitance (CL)	10 pF
Drive Level	0.2 mW
Pullability 7.5 ~ 14.8 pF	±70 PPM
Aging 10 years	±11 PPM
Maximum Soldering Temperature/Time	260°C / 10 seconds
Moisture Sensitivity Level (MSL)	1
Termination Finish	Au
Weight (Typ)	42.78 mg

Note: Dimensional drawing is for reference to critical specifications defined by size measurements. Certain non-critical visual attributes, such as side castellations, etc. may vary. The above specifications, having been carefully prepared and checked, is believed to be accurate at the time of publication; however, no responsibility is assumed by IDT for inaccuracies. All specifications subject to change without notice.

Package Outline and Dimensions (JB4)



Ordering Information

Part / Order Number	Shipping Packaging	Package	Temperature
495-25-141JB4I	Cut-Tape	5.0 x 3.2 x 0.7 mm JB4	-40 to +85 °C
495-25-141JB4I8	Tape and Reel	5.0 x 3.2 x 0.7 mm JB4	-40 to +85 °C



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### Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

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